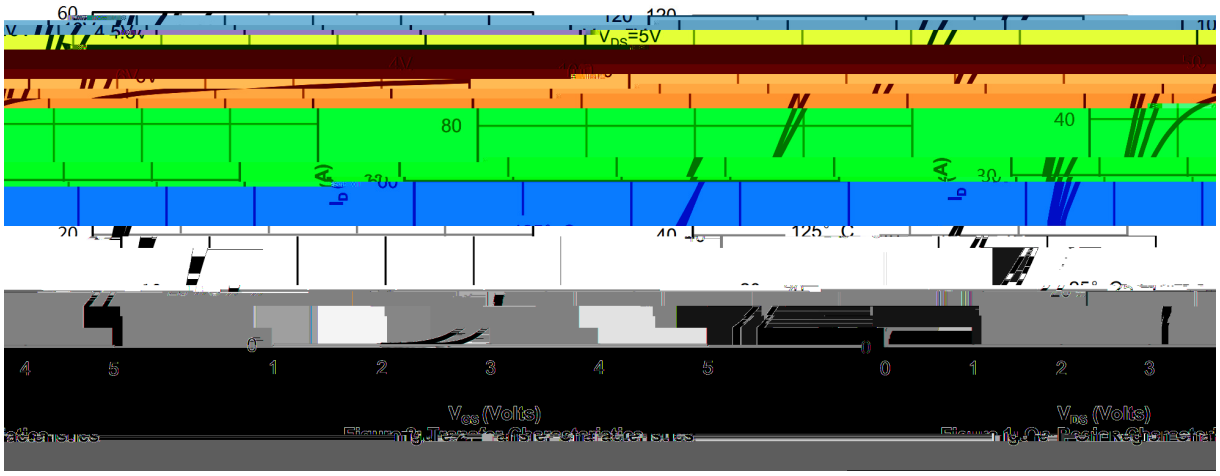
		±	

Ω

/ Electrical Characteristic Curve



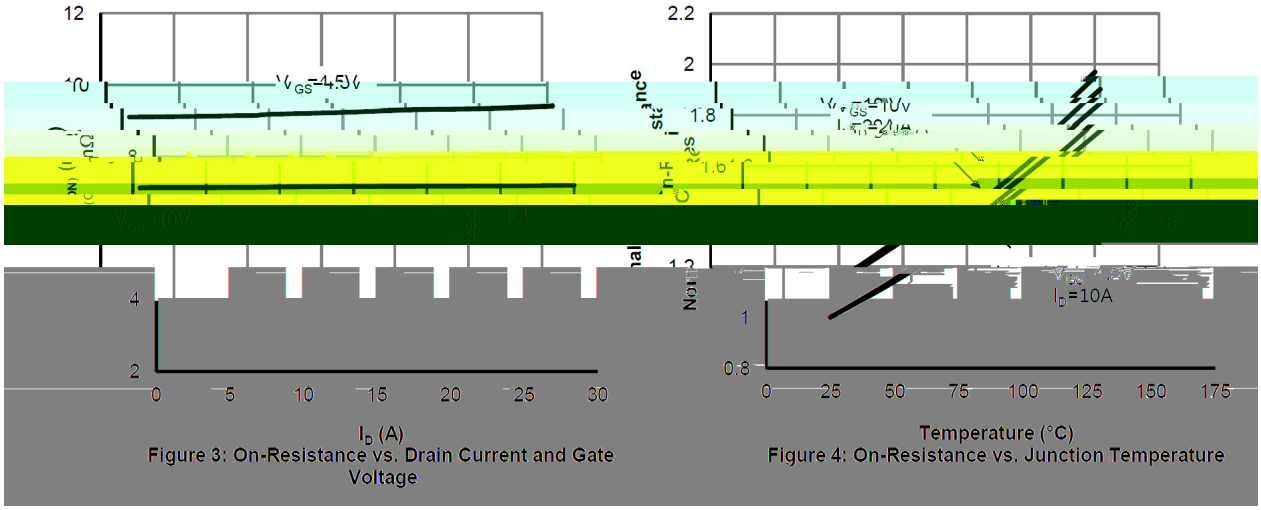


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

Figure 4: On-Resistance vs. Junction Temperature

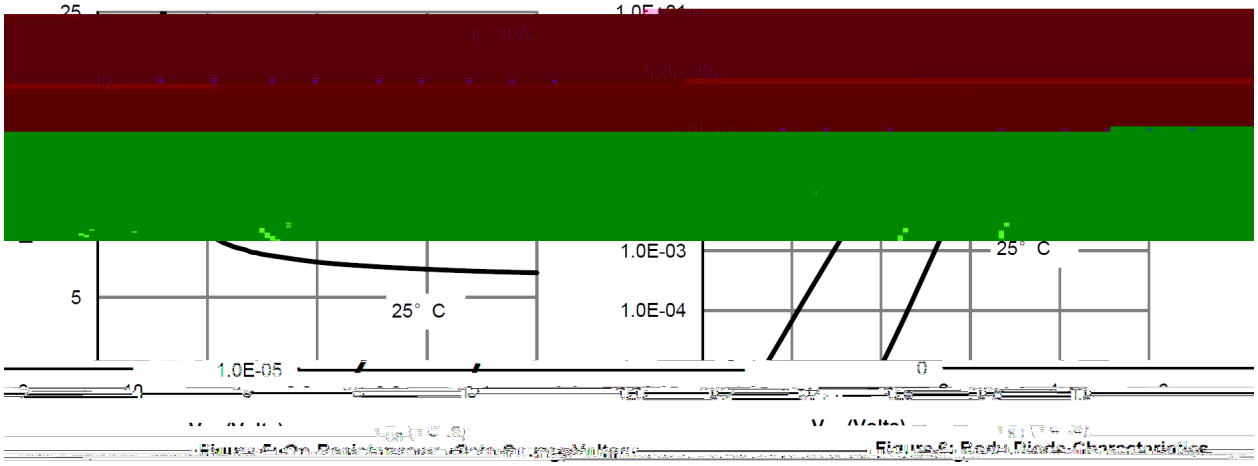


Figure 5: On-Resistance vs. Gate-Source Voltage

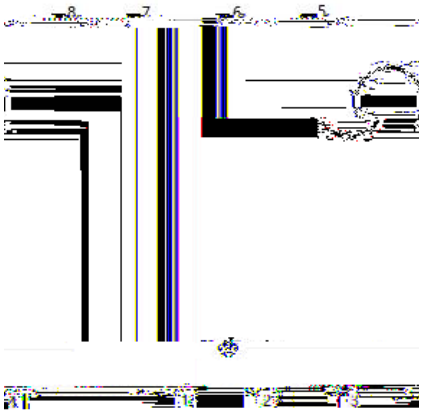
Figure 6: Body Diode Characteristics

/ Package Dimensions



Symbol	Dimensions In Millmeters	
	Min	Max
A	0.90	1.10
D	4.80	5.00
D1	4.80	5.20
D2	3.80	4.20
E	5.65	5.85
E1	5.80	6.20
E2	3.30	3.65
K	1.30 BSC	
e	1.27 BSC	
b	0.25	0.35
c	0.20	0.30
L	0.45	0.75

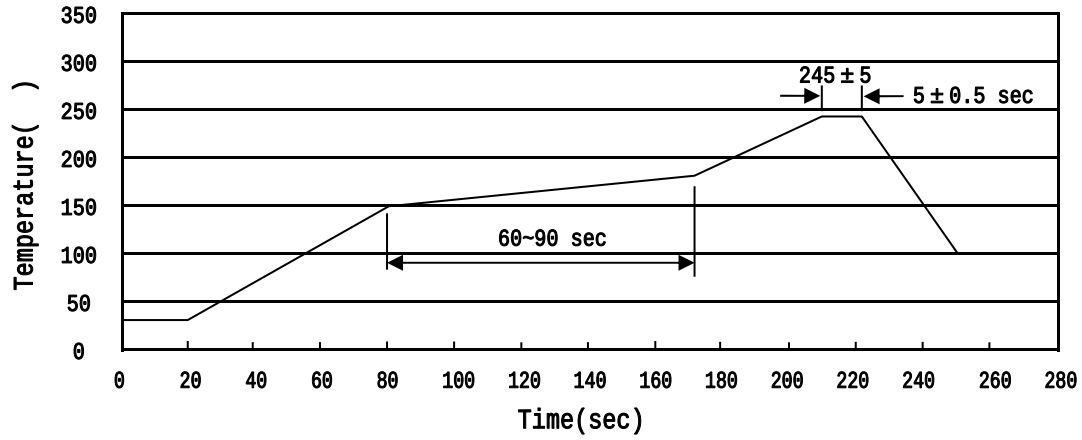
/ Marking Instructions



BR

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( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box

/ Notices